Attorney Docket No.: 2000IP000

IN THE UNITED STATES PATENT AND TRADEMARK OFFIC

In re Patent Application of:

Neal G. Skinner

TC 2800 MAIL RC

Serial No.:

09/932,639

Filed:

August 17, 2001

Entitled:

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Group Art Unit:

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INFORMATION DISCLOSURE STATEMENT

Technology Center 2600

Commissioner for Patents Washington, D.C. 20231

Sir:

As listed on the accompanying form PTO-SB-08, the Applicant hereby calls the examiner's attention to the following information of which he is aware, in respect of which there may be a duty to disclose in accordance with 37 CFR §1.56. Copies of the listed references are enclosed with this Information Disclosure Statement.

U.S. Patents:

5,315,110

5,502,589

6,038,357

4,495,421

5,077,816

6,115,156

This Information Disclosure Statement is being filed under the provisions of 37 CFR §1.97(b)(3), which provides for the timely filing of an Information Disclosure Statement before the mailing of a first Office Action on the merits.

The filing of this Information Disclosure Statement shall not be construed as a representation that a search has been made, an admission that the information cited is, or is considered to be, material to patentability, or that no other material information

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exists. Further, the filing of this Information Disclosure Statement shall not be construed as an admission against interest in any manner.

Written notification that the enclosed documents have been considered in their entirety, by return of a copy of the enclosed form completed by the examiner, is respectfully requested.

Respectfully submitted,

KONNEKER & SMITH, P.C.

Marlin R. Smith

Attorney for Applicant Registration No. 38,310

Dated: Feb. 19, 2002

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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Washington, D.C., 20231,